

SGP02N120 SGI02N120

Fast IGBT in NPT-technology

- 40% lower *E*_{off} compared to previous generation
- Short circuit withstand time 10 μs
- Designed for:
 - Motor controls
 - Inverter
 - SMPS
- NPT-Technology offers:
 - very tight parameter distribution
 - high ruggedness, temperature stable behaviour
 - parallel switching capability







- Qualified according to JEDEC¹ for target applications
- Pb-free lead plating; RoHS compliant
- Complete product spectrum and PSpice Models : http://www.infineon.com/igbt/

Туре	V _{CE}	I _C	$oldsymbol{\mathcal{E}}_{off}$	T _j	Marking	Package
SGP02N120	1200V	2A	0.11mJ	150°C	GP02N120	PG-TO-220-3-1
SGD02N120	1200V	2A	0.11mJ	150°C	02N120	PG-TO-252-3-11
SGI02N120	1200V	2A	0.11mJ	150°C	GI02N120	PG-TO-262-3-1

Maximum Ratings

Parameter	Symbol	Value	Unit
Collector-emitter voltage	V _{CE}	1200	V
DC collector current	I _C		А
$T_{\rm C}$ = 25°C		6.2	
$T_{\rm C}$ = 100°C		2.8	
Pulsed collector current, t_p limited by T_{jmax}	I _{Cpuls}	9.6	
Turn off safe operating area	-	9.6	
$V_{CE} \le 1200 \text{V}, \ T_j \le 150^{\circ} \text{C}$			
Gate-emitter voltage	V_{GE}	±20	V
Avalanche energy, single pulse	E _{AS}	10	mJ
$I_{\rm C}$ = 2A, $V_{\rm CC}$ = 50V, $R_{\rm GE}$ = 25 Ω , start at $T_{\rm j}$ = 25 $^{\circ}$ C			
Short circuit withstand time ²	tsc	10	μs
$V_{\rm GE}$ = 15V, 100V $\leq V_{\rm CC} \leq$ 1200V, $T_{\rm j} \leq$ 150°C			
Power dissipation	P _{tot}	62	W
$T_{\rm C}$ = 25°C			
Operating junction and storage temperature	$T_{\rm j}$, $T_{ m stg}$	-55+150	°C
Soldering temperature, PG-TO252 (reflow soldering, MSL3) Other packages: 1.6mm (0.063 in.) from case for 10s	-	260 260	

¹ J-STD-020 and JESD-022

² Allowed number of short circuits: <1000; time between short circuits: >1s.



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Thermal Resistance

Parameter	Symbol	Conditions	Max. Value	Unit
Characteristic	1			1
IGBT thermal resistance,	R_{thJC}		2.0	K/W
junction – case				
Thermal resistance,	R_{thJA}	PG-TO-220-3-1	62	
junction – ambient		PG-TO-262-3-1		
SMD version, device on PCB ¹⁾	R_{thJA}	PG-TO-252-3-11	50	

Electrical Characteristic, at T_j = 25 °C, unless otherwise specified

Davameter	Cumbal	Conditions	Value		lue	Unit
Parameter	Symbol	Conditions	min.	typ.	max.	Unit
Static Characteristic						•
Collector-emitter breakdown voltage	V _{(BR)CES}	$V_{\rm GE} = 0 \text{V}, I_{\rm C} = 100 \mu \text{A}$	1200	-	-	V
Collector-emitter saturation voltage	$V_{CE(sat)}$	$V_{\rm GE} = 15 \text{V}, I_{\rm C} = 2 \text{A}$				
		<i>T</i> _j =25°C	2.5	3.1	3.6	
		T _j =150°C	-	3.7	4.3	
Gate-emitter threshold voltage	$V_{\rm GE(th)}$	$I_{\rm C} = 100 \mu A, V_{\rm CE} = V_{\rm GE}$	3	4	5	
Zero gate voltage collector current	I _{CES}	V _{CE} =1200V, V _{GE} =0V				μΑ
		T _j =25°C	-	-	25	
		T _j =150°C	-	-	100	
Gate-emitter leakage current	I _{GES}	V _{CE} =0V, V _{GE} =20V	-	-	100	nA
Transconductance	g_{fs}	V_{CE} =20V, I_{C} =2A		1.5	-	S
Dynamic Characteristic	•		,		,	
Input capacitance	Ciss	V _{CE} =25V,	-	205	250	pF
Output capacitance	Coss	V _{GE} =0V,	-	20	25	
Reverse transfer capacitance	Crss	f=1MHz	-	12	14	
Gate charge	Q _{Gate}	V _{CC} =960V, I _C =2A	-	11	-	nC
		V _{GE} =15V				
Internal emitter inductance	LE		-	7	-	nΗ
measured 5mm (0.197 in.) from case						
Short circuit collector current ²⁾	$I_{C(SC)}$	$V_{\text{GE}} = 15V, t_{\text{SC}} \le 10 \mu \text{s}$ $100V \le V_{\text{CC}} \le 1200V,$ $T_{\text{j}} \le 150^{\circ} \text{C}$	-	24	-	A

2 **Power Semiconductors** Rev. 2.3 Sep. 07

 $^{^{1)}}$ Device on 50mm*50mm*1.5mm epoxy PCB FR4 with 6cm² (one layer, 70µm thick) copper area for collector connection. PCB is vertical without blown air. $^{2)}$ Allowed number of short circuits: <1000; time between short circuits: >1s.



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Switching Characteristic, Inductive Load, at T_i =25 °C

Dovometer	arameter Symbol Conditions		Value			Unit
Parameter			min.	typ.	max.	ns
IGBT Characteristic						
Turn-on delay time	$t_{d(on)}$	T _j =25°C,	-	23	30	ns
Rise time	tr	$V_{CC} = 800 \text{V}, I_{C} = 2\text{A},$	-	16	21	
Turn-off delay time	$t_{d(off)}$	$V_{GE}=15V/0V$,	-	260	340	
Fall time	t _f	$R_{\rm G}$ =91 Ω ,	-	61	80	
Turn-on energy	Eon	$L_{\sigma}^{(1)}$ =180nH, $C_{\sigma}^{(1)}$ =40pF Energy losses include	-	0.16	0.21	mJ
Turn-off energy	E _{off}		-	0.06	0.08	
Total switching energy	E _{ts}	"tail" and diode reverse recovery.	-	0.22	0.29	

Switching Characteristic, Inductive Load, at T_j =150 °C

Parameter	Symbol	Conditions	Value			Heit
Parameter	Symbol Co		min.	typ.	max.	ns mJ
IGBT Characteristic						
Turn-on delay time	$t_{d(on)}$	T _j =150°C	_	26	31	ns
Rise time	tr	V _{CC} =800V,	-	14	17	
Turn-off delay time	$t_{d(off)}$	$I_{\rm C}$ =2A,	-	290	350	
Fall time	t_{f}	V_{GE} =15V/0V,	-	85	102	
Turn-on energy	Eon	$R_{\rm G} = 91\Omega$,	-	0.27	0.33	mJ
Turn-off energy	E _{off}	$-L_{\sigma}^{1)}$ =180nH, $-L_{\sigma}^{1)}$ =40pF Energy losses include "tail" and diode reverse recovery.	-	0.11	0.15	
Total switching energy	E _{ts}		-	0.38	0.48	

 $^{^{1)}}$ Leakage inductance L_{σ} and stray capacity C_{σ} due to dynamic test circuit in figure E.



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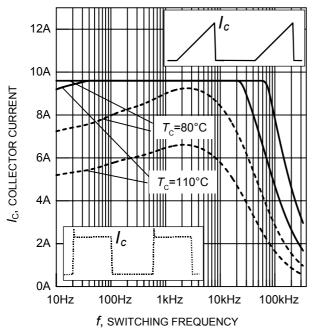


Figure 1. Collector current as a function of switching frequency

 $(T_{\rm j} \le 150^{\circ}\text{C}, D = 0.5, V_{\rm CE} = 800\text{V}, V_{\rm GE} = +15\text{V}/0\text{V}, R_{\rm G} = 91\Omega)$

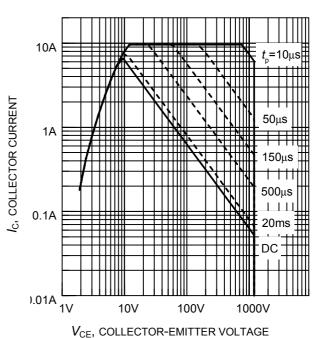


Figure 2. Safe operating area $(D = 0, T_C = 25^{\circ}C, T_i \le 150^{\circ}C)$

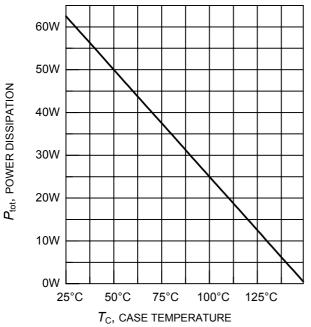


Figure 3. Power dissipation as a function of case temperature

 $(T_i \le 150^{\circ}C)$

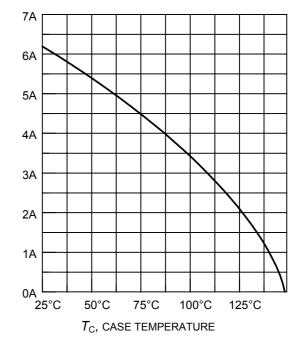


Figure 4. Collector current as a function of case temperature

 $(V_{GE} \le 15V, T_i \le 150^{\circ}C)$

Ic, COLLECTOR CURRENT



C, COLLECTOR CURRENT

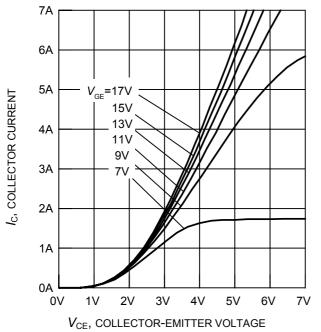


Figure 5. Typical output characteristics $(T_j = 25^{\circ}C)$

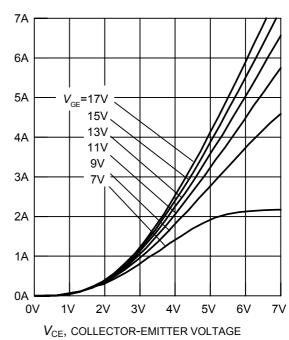


Figure 6. Typical output characteristics $(T_i = 150^{\circ}C)$

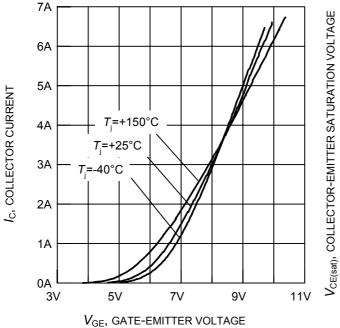


Figure 7. Typical transfer characteristics ($V_{CE} = 20V$)

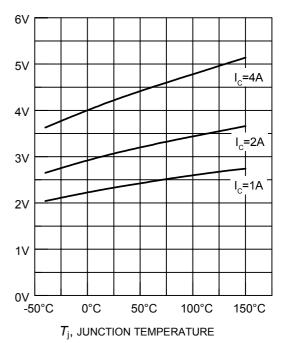


Figure 8. Typical collector-emitter saturation voltage as a function of junction temperature ($V_{\rm GE}$ = 15V)



 $V_{\text{GE(th)}}$, GATE-EMITTER THRESHOLD VOLTAGE

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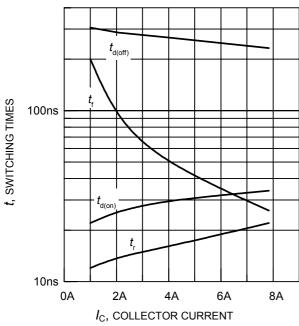


Figure 9. Typical switching times as a function of collector current (inductive load, $T_{\rm j}$ = 150°C, $V_{\rm CE}$ = 800V, $V_{\rm GE}$ = +15V/0V, $R_{\rm G}$ = 91 Ω , dynamic test circuit in Fig.E)

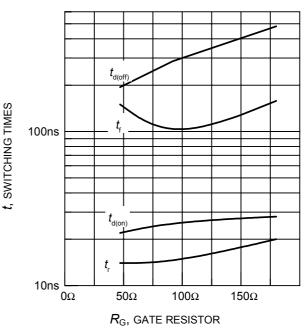


Figure 10. Typical switching times as a function of gate resistor (inductive load, $T_j = 150^{\circ}\text{C}$, $V_{\text{CE}} = 800\text{V}$, $V_{\text{GE}} = +15\text{V/OV}$, $I_{\text{C}} = 2\text{A}$, dynamic test circuit in Fig.E)

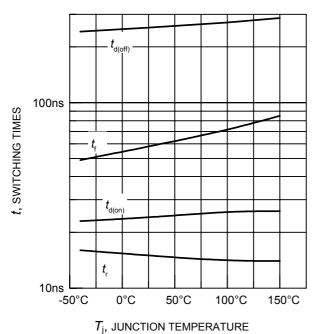


Figure 11. Typical switching times as a function of junction temperature (inductive load, $V_{\text{CE}} = 800\text{V}$, $V_{\text{GE}} = +15\text{V/OV}$, $I_{\text{C}} = 2\text{A}$, $R_{\text{G}} = 91\Omega$, dynamic test circuit in Fig.E)

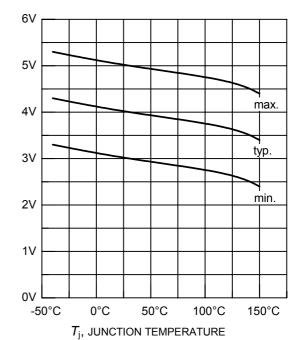


Figure 12. Gate-emitter threshold voltage as a function of junction temperature ($I_C = 0.3 \text{mA}$)



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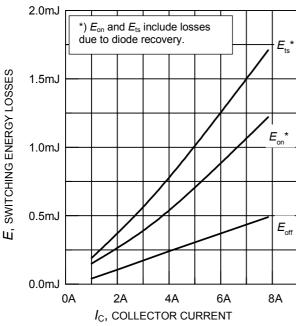
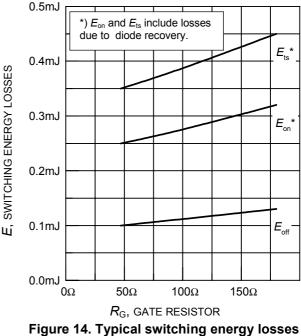


Figure 13. Typical switching energy losses as a function of collector current (inductive load, $T_{\rm j}$ = 150°C, $V_{\rm CE}$ = 800V, $V_{\rm GE}$ = +15V/0V, $R_{\rm G}$ = 91 Ω ,

dynamic test circuit in Fig.E)



as a function of gate resistor (inductive load, $T_{\rm j}$ = 150°C, $V_{\rm CE}$ = 800V, $V_{\rm GE}$ = +15V/0V, $I_{\rm C}$ = 2A, dynamic test circuit in Fig.E)

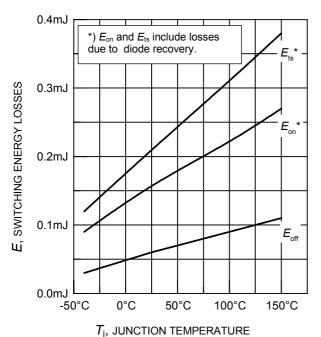


Figure 15. Typical switching energy losses as a function of junction temperature (inductive load, $V_{\text{CE}} = 800\text{V}$, $V_{\text{GE}} = +15\text{V/OV}$, $I_{\text{C}} = 2\text{A}$, $R_{\text{G}} = 91\Omega$, dynamic test circuit in Fig.E)

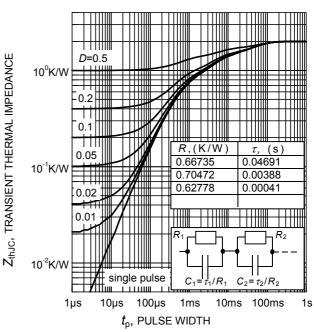
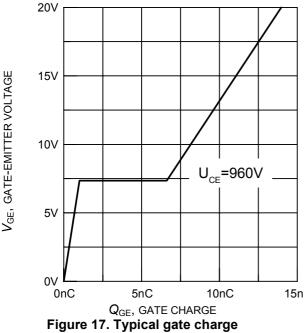


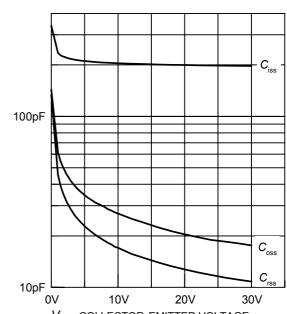
Figure 16. IGBT transient thermal impedance as a function of pulse width $(D = t_0 / T)$



C, CAPACITANCE



 $(I_{\rm C} = 2A)$



 V_{CE} , COLLECTOR-EMITTER VOLTAGE Figure 18. Typical capacitance as a function of collector-emitter voltage $(V_{GE} = 0V, f = 1MHz)$

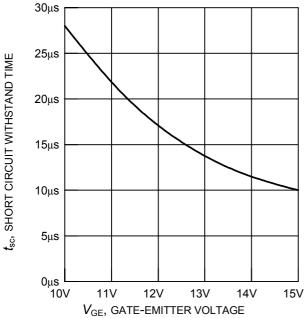


Figure 19. Short circuit withstand time as a function of gate-emitter voltage $(V_{CE} = 1200V, \text{ start at } T_i = 25^{\circ}C)$

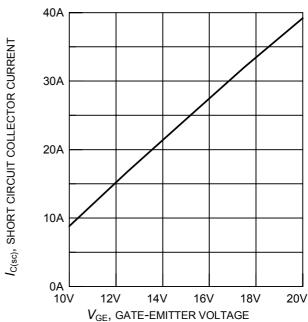
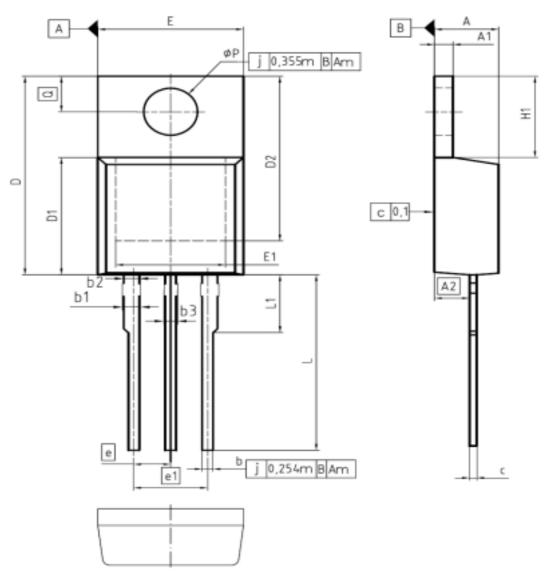


Figure 20. Typical short circuit collector current as a function of gate-emitter voltage $(100V \le V_{CE} \le 1200V, T_C = 25^{\circ}C, T_i \le 150^{\circ}C)$

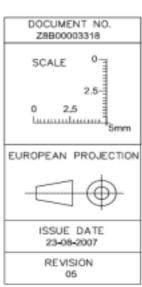


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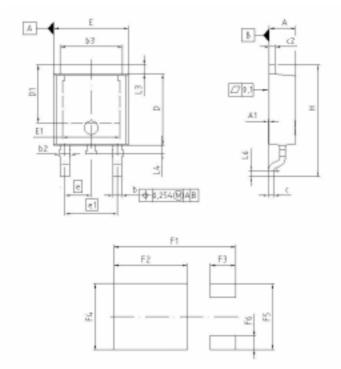
PG-TO220-3-1



MIN MAX MIN MAX A 4.30 4.57 0.169 0.180 A1 1.17 1.40 0.046 0.055 A2 2.15 2.72 0.085 0.107 b 0.65 0.86 0.026 0.034 b1 0.95 1.40 0.037 0.055 b2 0.95 1.15 0.037 0.045 b3 0.65 1.15 0.026 0.045 b 0.65 1.15 0.026 0.045 b3 0.65 1.15 0.026 0.045 c 0.33 0.60 0.013 0.024 D 14.81 15.96 0.583 0.628 D1 8.51 9.45 0.335 0.372 D2 12.19 13.10 0.480 0.516 E 9.70 10.36 0.382 0.408 E1 6.50 8.60 0.256 0.339 <tr< th=""><th>Dille</th><th>MILLIN</th><th>METERS</th><th>INC</th><th>(ES</th></tr<>	Dille	MILLIN	METERS	INC	(ES
A1 1.17 1.40 0.046 0.055 A2 2.15 2.72 0.085 0.107 b 0.65 0.86 0,026 0.034 b1 0.95 1.40 0.037 0.055 b2 0.95 1.15 0.037 0.045 b3 0.65 1.15 0.026 0.045 c 0.33 0.60 0.013 0.024 D 14.81 15.96 0.583 0.628 D1 8.51 9.45 0.335 0.372 D2 12.19 13.10 0.480 0.516 E 9.70 10.36 0.382 0.408 E1 6.50 8.60 0.256 0.339 e 2.54 0.100 e1 5.08 0.200 N 3 3 H1 5.90 6.90 0.232 0.272 L 13.00 14.00 0.512 0.551	DIM	MIN	MAX	MIN	MAX
A2 2.15 2.72 0.085 0.107 b 0.65 0.86 0.026 0.034 b1 0.95 1.40 0.037 0.055 b2 0.95 1.15 0.037 0.045 b3 0.65 1.15 0.026 0.045 c 0.33 0.60 0.013 0.024 D 14.81 15.96 0.583 0.628 D1 8.51 9.45 0.335 0.372 D2 12.19 13.10 0.480 0.516 E 9.70 10.36 0.382 0.408 E1 6.50 8.80 0.256 0.339 e 2.54 0.100 e1 5.08 0.200 N 3 3 H1 5.90 6.90 0.232 0.272 L 13.00 14.00 0.512 0.551 L1 - 4.80 - 0.189	Α	4.30	4.57	0.169	0.180
b 0.65 0.86 0.026 0.034 b1 0.95 1.40 0.037 0.055 b2 0.95 1.15 0.037 0.045 b3 0.65 1.15 0.026 0.045 c 0.33 0.60 0.013 0.024 D 14.81 15.96 0.583 0.628 D1 8.51 9.45 0.335 0.372 D2 12.19 13.10 0.480 0.516 E 9.70 10.36 0.382 0.408 E1 6.50 8.60 0.256 0.339 e 2.54 0.100 e1 5.08 0.200 N 3 3 H1 5.90 6.90 0.232 0.272 L 13.00 14.00 0.512 0.551 L1 - 4.80 - 0.189 aP 3.60 3.89 0.142 0.153	A1	1.17	1.40	0.046	0.055
b1 0.95 1.40 0.037 0.055 b2 0.95 1.15 0,037 0.045 b3 0.65 1.15 0,026 0.045 c 0.33 0.60 0.013 0.024 D 14.81 15.96 0.583 0.628 D1 8.51 9.45 0.335 0.372 D2 12.19 13.10 0.480 0.516 E 9.70 10.36 0.382 0.408 E1 6.50 8.60 0.256 0.339 e 2.54 0.100 e1 5.08 0.200 N 3 3 H1 5.90 6.90 0.232 0.272 L 13.00 14.00 0.512 0.551 L1 - 4.80 - 0.189 aP 3.60 3.89 0.142 0.153	A2	2.15	2.72	0,085	0.107
b2 0.95 1.15 0.037 0.045 b3 0.65 1.16 0.026 0.045 c 0.33 0.60 0.013 0.024 D 14.81 15.96 0.583 0.628 D1 8.51 9.45 0.335 0.372 D2 12.19 13.10 0.480 0.516 E 9.70 10.36 0.382 0.408 E1 6.50 8.60 0.256 0.339 e 2.54 0.100 e1 5.08 0.200 N 3 3 H1 5.90 6.90 0.232 0.272 L 13.00 14.00 0.512 0.551 L1 - 4.80 - 0.189 aP 3.60 3.89 0.142 0.153	ь	0.65	0.86	0,026	0.034
b3 0.65 1.15 0,026 0.045 c 0.33 0.60 0.013 0.024 D 14.81 15.96 0.583 0.628 D1 8.51 9.45 0.335 0.372 D2 12.19 13.10 0.480 0.516 E 9.70 10.36 0.382 0.408 E1 6.50 8.60 0.256 0.339 e 2.54 0.100 e1 5.08 0.200 N 3 3 H1 5.90 6.90 0.232 0.272 L 13.00 14.00 0.512 0.551 L1 - 4.80 - 0.189 aP 3.60 3.89 0.142 0.153	ь1	0.95	1.40	0.037	0.055
c 0.33 0.60 0.013 0.024 D 14.81 15.95 0.583 0.628 D1 8.51 9.45 0.335 0.372 D2 12.19 13.10 0.480 0.516 E 9.70 10.36 0.382 0.408 E1 6.50 8.60 0.256 0.339 e 2.54 0.100 e1 5.08 0.200 N 3 3 H1 5.90 6.90 0.232 0.272 L 13.00 14.00 0.512 0.551 L1 - 4.80 - 0.189 aP 3.60 3.89 0.142 0.153	ь2	0.95	1.15	0,037	0,045
D 14.81 15.95 0.583 0.628 D1 8.51 9.45 0.335 0.372 D2 12.19 13.10 0.480 0.516 E 9.70 10.36 0.382 0.408 E1 6.50 8.60 0.256 0.339 e 2.54 0.100 e1 5.08 0.200 N 3 3 H1 5.90 6.90 0.232 0.272 L 13.00 14.00 0.512 0.551 L1 - 4.80 - 0.189 aP 3.60 3.89 0.142 0.153	ь3	0,65	1,15	0,026	0,045
D1 8.51 9.45 0.335 0.372 D2 12.19 13.10 0.480 0.516 E 9.70 10.36 0.382 0.408 E1 6.50 8.60 0.256 0.339 e 2.54 0.100 e1 5.08 0.200 N 3 3 H1 5.90 6.90 0.232 0.272 L 13.00 14.00 0.512 0.551 L1 - 4.80 - 0.189 aP 3.60 3.89 0.142 0.153	С	0.33	0.60	0.013	0.024
D2 12.19 13.10 0.480 0.516 E 9.70 10.36 0.382 0.408 E1 6.50 8.60 0.256 0.339 e 2.54 0.100 e1 5.08 0.200 N 3 3 H1 5.90 6.90 0.232 0.272 L 13.00 14.00 0.512 0.551 L1 - 4.80 - 0.189 aP 3.60 3.89 0.142 0.153	D	14.81	15.95	0.583	0.628
E 9.70 10.36 0.382 0.408 E1 6.50 8.60 0,256 0,339 e 2.54 0.100 e1 5.08 0.200 N 3 3 3 H1 5.90 6.90 0.232 0.272 L 13.00 14.00 0.512 0.551 L1 - 4.80 - 0.189 eP 3.60 3.89 0.142 0.153	D1	8.51	9.45	0,335	0.372
E1 6,50 8,60 0,256 0,339 e 2.54 0.100 e1 5,08 0,200 N 3 3 H1 5,90 6,90 0,232 0,272 L 13,00 14,00 0,512 0,551 L1 - 4,80 - 0,189 aP 3,60 3,89 0,142 0,153	D2	12.19	13.10	0.480	0.516
e 2.54 0.100 e1 5.08 0.200 N 3 3 H1 5.90 6.90 0.232 0.272 L 13.00 14.00 0.512 0.551 L1 - 4.80 - 0.189 eP 3.60 3.89 0.142 0.153	E	9.70	10.36	0.382	0.408
e1 5.08 0.200 N 3 3 H1 5.90 6.90 0.232 0.272 L 13.00 14.00 0.512 0.551 L1 - 4.80 - 0.189 aP 3.60 3.89 0.142 0.153	E1	6,50	8,60	0,256	0,339
N 3 3 3 H1 5.90 6.90 0.232 0.272 L 13.00 14.00 0.512 0.551 L1 - 4.80 - 0.189 eP 3.60 3.89 0.142 0.153	e	2	.54	0.100	
H1 5.90 6.90 0.232 0.272 L 13.00 14.00 0.512 0.551 L1 - 4.80 - 0.189 aP 3.60 3.89 0.142 0.153	e1	5	.08	0.200	
L 13.00 14.00 0.512 0.551 L1 - 4.80 - 0.189 aP 3.60 3.89 0.142 0.153	N		3		3
L1 - 4.80 - 0.189 &P 3.60 3.89 0.142 0.153	H1	5.90	6.90	0.232	0.272
øP 3.60 3.89 0.142 0.153	L	13.00	14.00	0.512	0.551
	L1	-	4.80	-	0.189
Q 2.60 3.00 0.102 0.118	æР	3.60	3.89	0.142	0.153
	Q	2.60	3.00	0.102	0.118







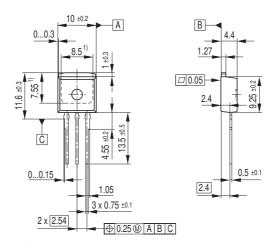
PG-TO252-3-11

DIM	MILLIM	ETERS	INCI	HES	
DIM	MIN	MAX	MIN	MAX	
A	2.184	2.388	0.068	0.094	
A1	0.000	0.150	0.000	0.006	
b	0.835	0.889	0.025	0.035	
b2	0.650	1.150	0.025	0.045	
b3	5.004	5.500	0.197	0.217	
0	0.490	0.580	0.048	0.023	
c2:	9,490	0.960	0.048	0.039	
D	5.999	6.223	0.235	0.245	
D1	5.020	5.320	0.196	0.209	
E	5.400	5.734	0.252	0.285	
E1	4.900	5.100	0.193	0.201	
	2.2	96	0.090		
e1	4,5	72	0.1	180-	
N	3			3	
н	9,400	10,094	0.370	0.397	
L3	0.900	1,118	0.095	0.044	
L4	0.690	1,016	0.026	0.040	
LG	0.510	0.686	0.029	0.027	
P1	10.500	10.700	0.413	0.421	
F2	5.300	5.500	0.248	0.256	
F3	2.900	2.300	0.063	0.091	
F4	5.700	5.900	0.224	0.232	
FS	5,660	5.880	0.222	0.231	
F6	1.100	1.300	0.043	0.051	



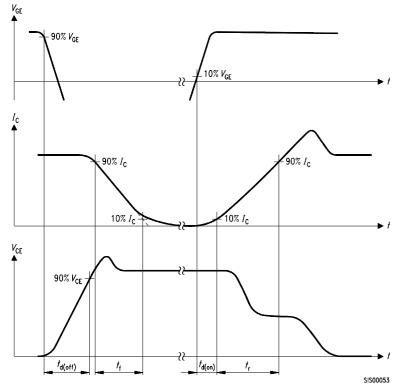
SGP02N120 SGI02N120

PG-TO262-3-1 (I² Pak)



Typical Metal surface min. X = 7.25, Y = 6.9 All metal surfaces tin plated, except area of cut.





 $di_{F}/dt \qquad t_{rr} = t_{S} + t_{F}$ $Q_{rr} = Q_{S} + Q_{F}$ $t_{rr} = t_{S} + t_{F}$ $Q_{rr} = Q_{S} + Q_{F}$ $di_{rr} = t_{S} + t_{F}$ $di_{rr} = t_{S} + t_{F}$

Figure C. Definition of diodes switching characteristics

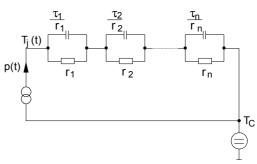


Figure A. Definition of switching times

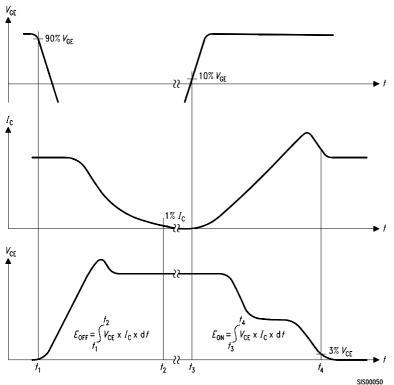


Figure D. Thermal equivalent circuit

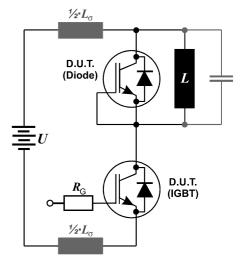


Figure B. Definition of switching losses

Figure E. Dynamic test circuit Leakage inductance L_{σ} =180nH, and stray capacity C_{σ} =40pF.



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Edition 2006-01

Published by Infineon Technologies AG 81726 München, Germany © Infineon Technologies AG 9/12/07.

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